

For immediate release

900 Middlesex Turnpike, Bldg. 6
Billerica, MA 01821-3929

For further information:

Richard S. Post
Chief Executive Officer
978-932-2030

NEXX Systems Ships Stratus 300 mm Tool to a Singapore Customer

Billerica, MA – July 22, 2008 – NEXX Systems today announced that it has shipped a Stratus S300 (300 mm) electrodeposition system to Singapore, representing the second Stratus 300 mm tool to be installed at this company for high-volume production. With the inherent simplicity of the Stratus, NEXX anticipates production start-up in August.

"This shipment," stated Richard Post, CEO of NEXX Systems, "represents an important milestone in the market acceptance of the Stratus platform. We now have multiple customers who are purchasing follow-on Stratus tools to handle their high-volume production requirements in both 200 and 300 mm packaging applications."

The Stratus provides industry-leading yield at the lowest cost of ownership for pattern plating and TSV applications. Innovative ShearPlate™ technology eliminates the complex process tuning and process drift adjustment required by competing multi-zone anode fountain tools. The Stratus is the technology leader for TSV, solder bumping, copper pillar, UBM, and other advanced packaging applications.

About NEXX Systems: NEXX Systems brings exceptional technical expertise to flip chip and advanced packaging. Our product lines provide the most efficient, yet affordable, systems of their kind: Apollo for multi-layer sputter deposition of metals, and Stratus for high throughput electrodeposition of metals. Additional information can be found at: www.nexxsystems.com.

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